





Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			100	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T <sub>C</sub> = 25 °C		20		
I <sub>D</sub>	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	7	A	
	-Pulsed		(Note 4)	60		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	72	mJ	
D	Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			41	w	
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.3	V	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

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# **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case	3	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a	53	C/VV

# **Package Marking and Ordering Information**

Device Marking	Device	Package	Package Reel Size Tape Width		Quantity
FDMC86102	FDMC86102	Power 33	13"	12 mm	3000 units

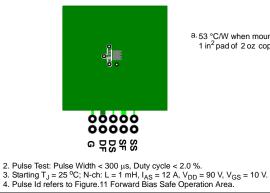
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FDMC86102 N
N-Channel S
el Shieldec
Shielded Gate PowerTrench
erTrench <sup>®</sup>
MOSFET

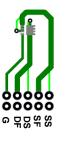
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, V_{GS} = 0 \ V$	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		69		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	acteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \ \mu A$	2.0	3.1	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-9		mV/°C
-		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 7 A		19.4	24	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 6 V, I_{D} = 5 A$		26.8	38	mΩ
		$V_{GS} = 10 \text{ V}, \ \text{I}_{D} = 7 \text{ A}, \text{T}_{J} = 125 ^{\circ}\text{C}$		32.8	41	
9 <sub>FS</sub>	Forward Transconductance	$V_{DD} = 10 \text{ V}, \ \text{I}_{D} = 7 \text{ A}$		19		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			725	965	pF
C <sub>oss</sub>	Output Capacitance	──V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, ──f = 1 MHz		175	235	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			15	25	pF
R <sub>g</sub>	Gate Resistance			0.5		Ω
Switchin	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			8	17	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 7 A,		4	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		14	25	ns
t <sub>f</sub>	Fall Time			4	10	ns
0	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		13	18	nC
Q <sub>g(TOT)</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 50 V$		8	11	nC
Q <sub>gs</sub>	Total Gate Charge	I <sub>D</sub> = 7 A		3.7		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			3.6		nC
Drain-So	urce Diode Characteristics					
V		$V_{GS} = 0 V, I_S = 7 A$ (Note 2)		0.81	1.3	V
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 2 \text{ A} \qquad (\text{Note 2})$		0.75	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	— I <sub>F</sub> = 7 A, di/dt = 100 A/μs		44	70	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$r_F = r R$ , uvut = 100 A/µs	-	40	65	nC

Q<sub>rr</sub> NOTES:

1.  $R_{0JA}$  is determined with the device mounted on a 1in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material.  $R_{0JC}$  is guaranteed by design while  $R_{0CA}$  is determined by the user's board design.



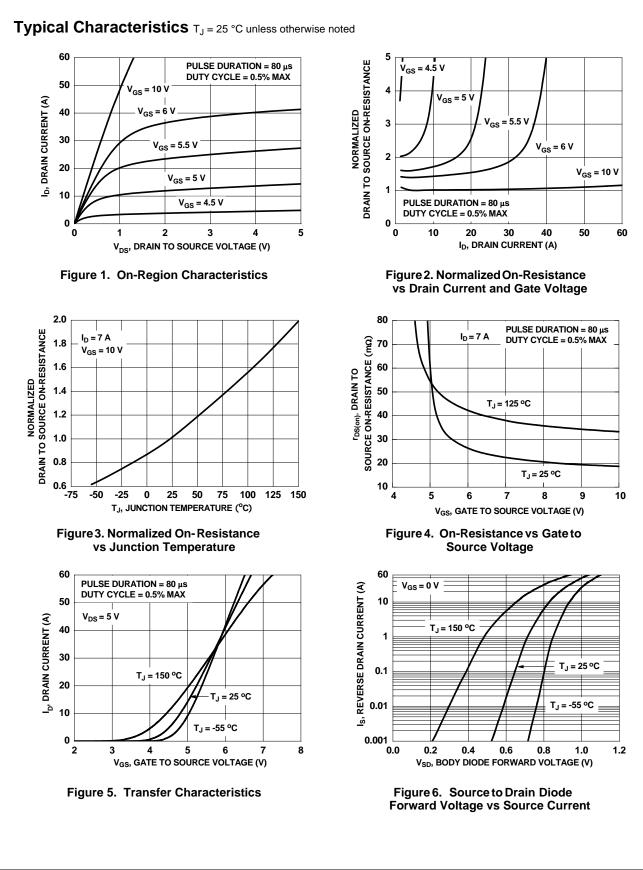
a.53 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



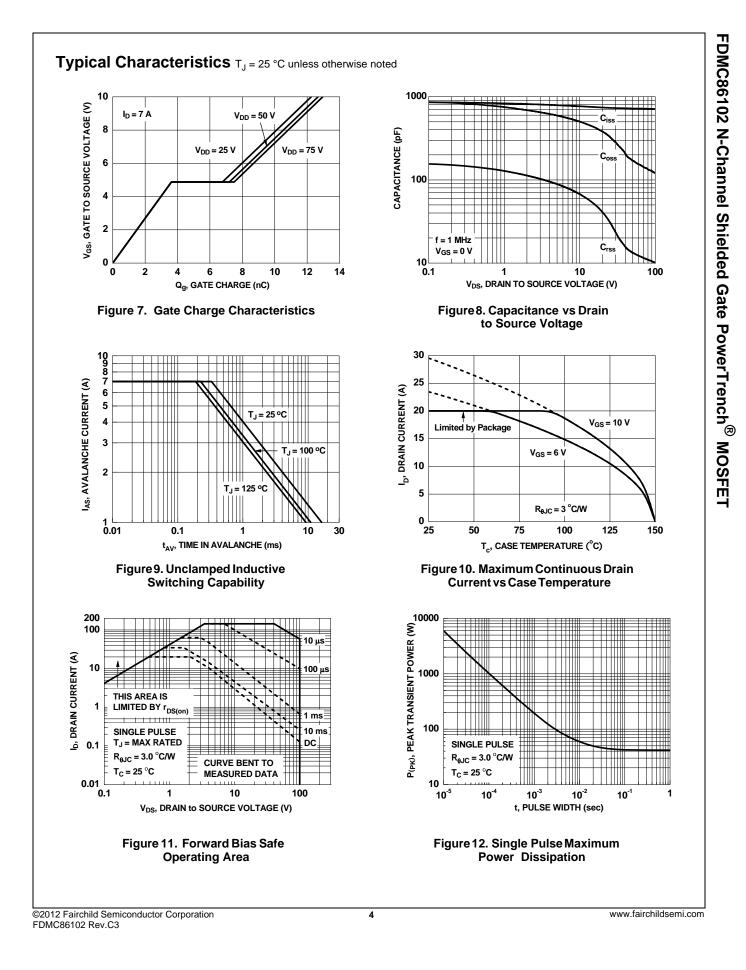
b. 125 °C/W when mounted on a minimum pad of 2 oz copper

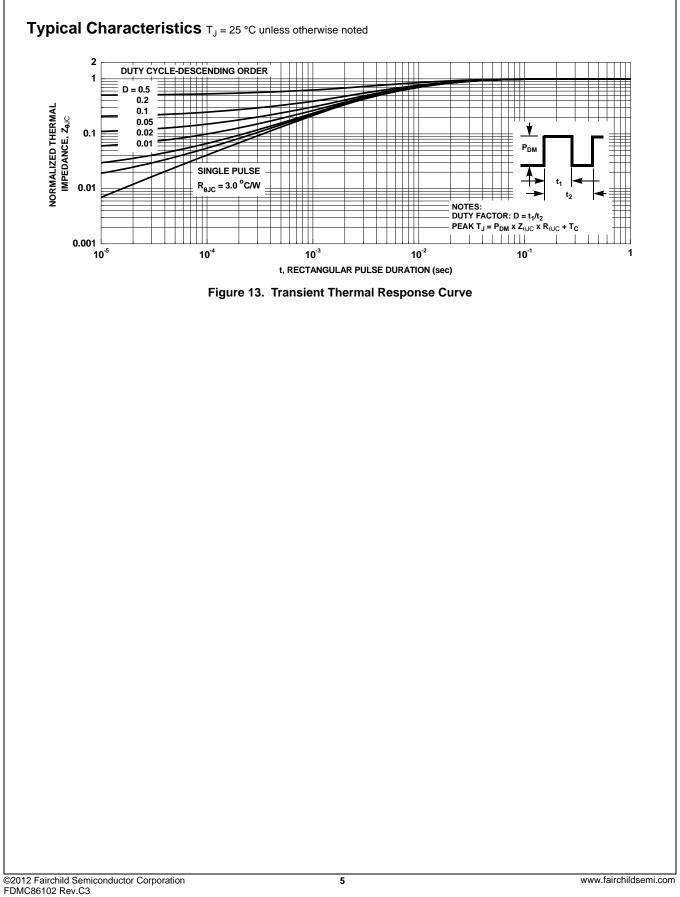
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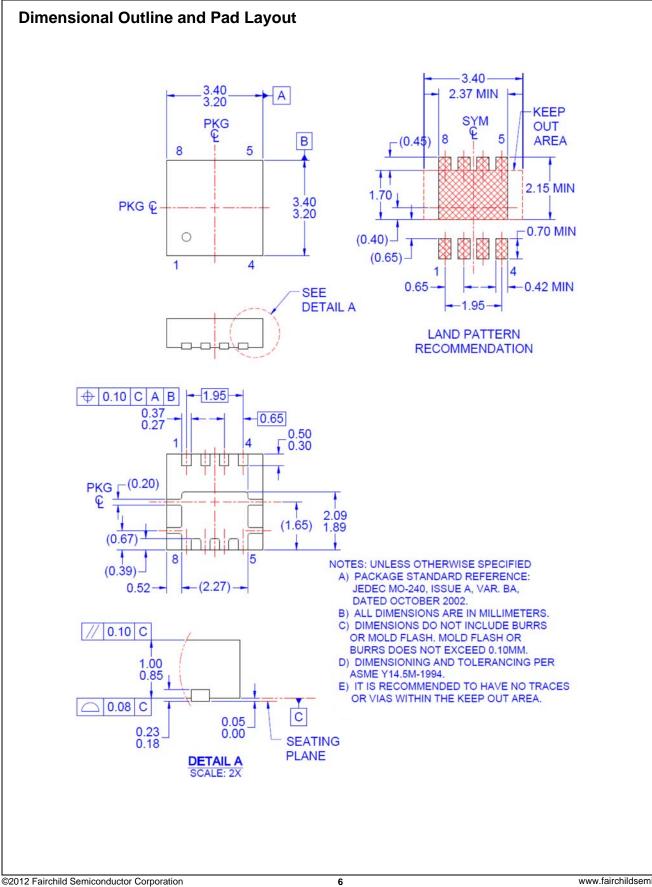


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FDMC86102 N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET



FDMC86102 Rev.C3

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